



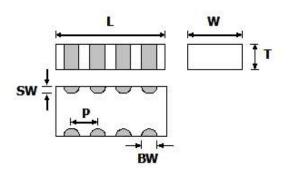
# SPECIFICATION (Reference sheet)

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- Samsung P/N : CL10Y104MR5NJNC
- Description : CAP, 100 nF, 4V, ±20%, X7S, 0603

A. Samsung F	Part Number
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		<u>CL</u>	<u>10</u>	<u>Y</u>	<u>104</u>	M	<u>R</u>	<u>5</u>	<u>N</u>	<u>J</u>	<u>N</u>	<u>C</u>
		1	2	3	4	5	6	1	8	9	10	1
1	Series	Samsung Multi-layer Ceramic Capacitor										
2	Size	0603 (inch c	ode)		L:	1.60	± 0.1	0	mm		W:	$0.80 \pm 0.10$ mm
3	Dielectric	X7S				8	Inne	r ele	ctroc	le		Ni
4	Capacitance	<b>100</b> nF					Tern	ninat	ion			Cu
5	Capacitance	±20 %					Plati	ng				Sn 100% (Pb Free)
	tolerance					9	Proc	luct				SLIC
6	Rated Voltage	4 V				10	Spee	cial				Reserved for future use
$\bigcirc$	Thickness	0.50 +0.05/-	-0.1	mm		1	Pack	agir	ng			Cardboard Type, 7" reel

### **B. Structure and Dimensions**



Samsung P/N	Dimension(mm)								
Sansung P/N	L	W	Т	BW	SW	Р			
CL10Y104MR5NJNC	1.60±0.10	0.80±0.10	0.5 +0.05/-0.1	0.25±0.10	0.15±0.10	0.40±0.10			

#### C. Samsung Reliablility Test and Judgement Condition

	Judgement	Test condition				
Capacitance	Within specified tolerance	1⊮ ±10% / 0.5±0.1Vrms				
Tan δ (DF)	0.12 max.					
Insulation	10,000Mohm or 50Mohm×µF	Rated Voltage 60~120 sec.				
Resistance	Whichever is smaller					
Appearance	No abnormal exterior appearance	Microscope (×10)				
Withstanding	No dielectric breakdown or	250% of the rated voltage				
Voltage	mechanical breakdown					
Temperature	X7S					
Characteristics	(From -55 ℃ to 125 ℃, Capacitance char	nge should be within ±22%)				
Adhesive Strength	No peeling shall be occur on the	500g·F, for 10±1 sec.				
of Termination	terminal electrode					
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)				
		with 1.0mm/sec.				
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder				
	is to be soldered newly	245±5℃, 3±0.3sec.				
		(preheating : 80~120 ℃ for 10~30sec.)				
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5℃, 10±1sec.				
Soldering heat	Tan δ, IR : initial spec.					
Vibration Test	Capacitance change : within ±20%	Amplitude : 1.5mm				
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)				
		2hours × 3 direction (x, y, z)				
Moisture	Capacitance change : within ±12.5%	With rated voltage				
Resistance	Tan δ : 0.2 max	40±2℃, 90~95%RH, 500+12/-0hrs				
	IR : 500Mohm or 12.5Mohm × μF					
	Whichever is smaller					
High Temperature	Capacitance change : within ±12.5%	With 150% of the rated voltage				
Resistance	Tan δ : 0.2 max	Max. operating temperature				
	IR : 1,000Mohm or 25Mohm × μF	1,000+48/-0hrs				
	Whichever is smaller					
Temperature	Capacitance change : within ±12.5%	1 cycle condition				
Cycling	Tan δ, IR : initial spec.	Min. operating temperature $\rightarrow$ 25 °C				
		$\rightarrow$ Max. operating temperature $\rightarrow$ 25 °C				
		5 cycle test				

 $\times$  The reliability test condition can be replaced by the corresponding accelerated test condition.

#### D. Recommended Soldering method :

Reflow ( Reflow Peak Temperature :  $260\pm5^{\circ}$ C, 30sec. )

Product specifications included in the specifications are effective as of March 1, 2013. Please be advised that they are standard product specifications for reference only. We may change, modify or discontinue the product specifications without notice at any time. So, you need to approve the product specifications before placing an order. Should you have any question regarding the product specifications, please contact our sales personnel or application engineers.

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- 2 Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- *④ Military equipment*
- *⑤* Disaster prevention/crime prevention equipment
- *ⓐ* Any other applications with the same as or similar complexity or reliability to the applications set forth above.